Leaded Chip Terminations Style LT

General Specifications

• Nominal Impedance: 50 Ω

• Resistive Tolerance: ±5% Standard

(2% Available).

• Operating Temp. Range: -55°C to +150°C

• Temperature Coefficient: ±150 ppm/°C

 Mechanical Tolerance: ±.010 inches (unless otherwise specified)

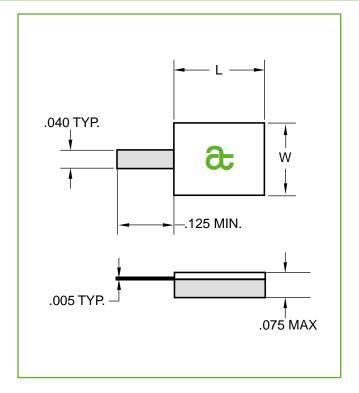
• Resistive Elements: Proprietary film.

Substrate Material: Aluminum Nitride.

Lead Terminals: 100% Silver

· Cover: Alumina

• Reliability: MIL-PRF-55342

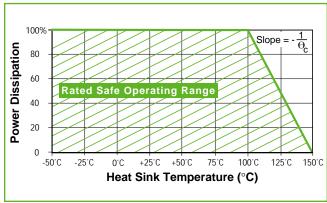


ATC Part Number	W ±.010	L ±.010	T ±.005	Frequency Range (GHz)	VSWR (Max)	Power Max* (Watts)
LT12010T0050J	.100	.200	.040	DC - 6.0	1.25:1	30
LT12525T0050J	.245	.245	.040	DC - 2.5	1.15:1	60
LT12335T0050J	.350	.230	.040	DC - 4.0	1.15:1	50
LT13725T0050J	.250	.375	.040	DC - 1.1	1.20:1	150
LT13737T0050J	.370	.370	.040	DC - 1.0	1.30:1	225

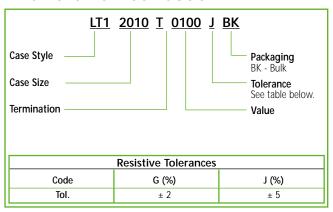
^{*} Test Condition: Chip soldered to a large copper carrier whose surface is at 100°C; maximum rated power applied.

Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per MIL-PRF-55342

Power Derating



ATC Part Number Code



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